FORM PTO-1595 (Rev. 6-93) OMB No. 0651-0011 (exp. 4/94) O - 38- 98 To the Honorable Commissioner of Patents and Tradem	74	VER SHEET Y the attached original documents	U.S. DEPARTMENT OF COM
Name of conveying part(ies): Tri-Rung Yew; Water Lur; and Shih-Wei Sun		e and address of receiving United Microelect	party(ies)
Additional name(s) of conveying party(ies) attached? ☐Yes ☒No	Street Ad	Idress: No. 3, Li-Hsin Rd Park, Hsinchu Cit Additional name(s) & address(e	
3. Nature of conveyance:			
 4. Application number(s) or patent number(s): If this document is being filed together with a new application, to A. Patent application No.(s) B. Patent 			otember 28, 1998 and September 30, 1998
Additional num	bers attached? Y	∕es ⊠No	
5. Name and address of party to whom correspondence concerning document should be mailed: Daniel R. McClure Thomas, Kayden, Horstemeyer & Risley, L.L.P. 100 Galleria Parkway, Suite 1500 Atlanta, Georgia 30339		number of applications/pat	tents involved: [1]
	⊠ Enc	fee (37 CFR 3.41) \$ 40. closed thorized to be charged to d	
		sit Account Number:	

Type Name of Person Signing - Daniel R. McClure

Docket #: 252103-2630

Total number of pages including cover sheet, attachments, and document: [3]

DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy

Mail documents to be recorded with required cover sheet information to:

Assistant Commissioner for Patents, Box Assignments AssignCoverSht.doc Washington, D.C. 20231

PATENT

REEL: 9555 FRAME: 0271

ASSIGNMENT

WHEREAS, (1) Tri-Rung Yew (3) Shih-Wei Sun

(2) Water Lur

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD OF FABRICATING A SHALLOW-TRENCH ISOLATION STRUCTURE IN INTEGRATED CIRCUIT

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Microelectronics Corp., of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

-1-

PATENT REEL: 9555 FRAME: 0272

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s)

indicated.	
Signature Sept. 28, 1998	
Signature Sep 29, 1998	
All Mai / Im 9/30/98	
Signature	
Signature	

RECORDED: 10/28/1998